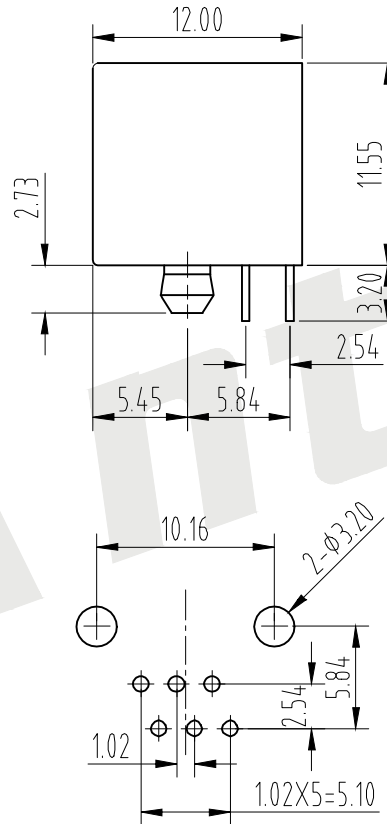
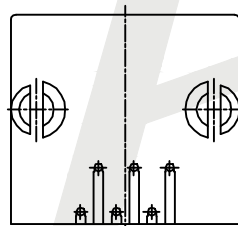
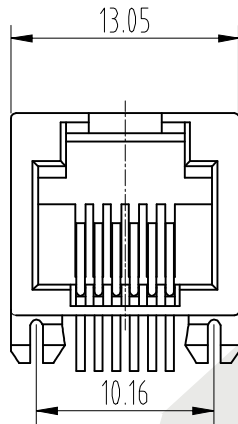


HSF

RoHS



PC Board Layout
Component Side Shown

NOTES:

MATERIAL:

1. HOUSING MATERIAL: GLASS FILLED POYESTER UL94V-0.
2. CONTACT MATERIAL: PHOSPHOR BRONZE $t=0.3\text{mm}$
3. PLATING: SELECTING GOLD PLATING $1\mu \sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATIN. OVER NICKEL IN SOLDER AREA
4. SHIELD: 0.2mm THICKNESS COPPER WITH NICKEL PLATE

ELECTRICAL

1. VOLTAGE RATING: 125VAC RMS
2. CURRENT RATING: 1.5AMP
3. CONTACT RESISTANCE: 30MILLIOHMS MAX
4. INSULATION RESISTANCE 500MEGOHMS MIN @500V DC
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN

MECHANICAL

1. DURRABILITY: 750 CYCLES MIN
2. PCB RETENTION PRB-SOLDER: 1 LB MIN

REVRONMENTAL

1. STORAGE: -40°C TO 85°C
2. OPERATION: 0°C TO 70°C

Order code:

ATRJ5322 - 6P - 6C - X - A

① ② ③ ④ ⑤

- ① SERIES NO:
 - ② NUMBER OF POSITIONS (8P, 6P, 4P)
 - ③ NUMBER OF CONTACTS (8C, 6C, 4C)
 - ④ Contact Plating
 - ⑤ Shield
- G0: Gold flash
 - G1: 3U" Gold
 - G2: 5U" Gold
 - G3: 10U" Gold
 - G4: 15U" Gold
 - G5: 30U" Gold
 - SN: Tin
 - A: W/O Shield
 - B: Half Shield
 - C: Shield W/Eml
 - D: Shield W/O Eml

Unless Otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15



ANTENK ELECTRONICS CO., LTD
[Http://www.antenk.com](http://www.antenk.com)
 E-mail: sales@antenk.com

SCALE: As Shown UNIT: mm
 DRAW Wu Feng Rong DATE 05/09/2019
 CHECK BobYang DATE 05/09/2019

TITLE: RJ11 Jack 6P6C, Side entry, 1X1Port, Full plastic MINI TYPE



DRAWING NO: ATRJ5322-6P6C-X-A

PRODUCT NO: ATRJ5322-6P6C-X-A

REV	DESCRIPTION	DATE